

SURFACE MOUNT

RF Transformer

75Ω 0.3 to 475 MHz

1C2-T-\2+

- *Addition of Top Hat® Feature Benefits
- Allows Faster Pick-and-Place
- Enables Visual Identification Marking



Generic photo used for illustration purposes only CASE STYLE: AT224-1A

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

FEATURES

- · Wideband, 0.3 to 475 MHz
- Good Return Loss, 23 dB Typ. in 1 dB Bandwidth
- Step-Down 9:1 Autotransformer
- Plastic Base with Leads
- Aqueous Washable

APPLICATIONS

Matching Laser Diode

ELECTRICAL SPECIFICATIONS AT +25°C

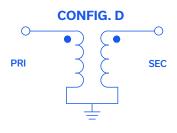
Parameter	Frequency (MHz)	Min.	Тур.	Max.	Unit
Impedance Ratio (Primary/Secondary)			75/8		Ohms
Frequency Range		0.3		475	MHz
	0.3-475		3		
Insertion Loss ¹	0.5-450		2		dB
	0.9-370		1		

^{1.} Insertion Loss is referenced to mid-band loss, 0.4 dB typ. Stepdown, 75Ω primary, 51 pF across secondary.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-20°C to +85°C
Storage Temperature	-55°C to +100°C
RF Power	0.25 W
DC Current	30 mA

Permanent damage may occur if any of these limits are exceeded.







SURFACE MOUNT

RF Transformer

TC9-1-75+

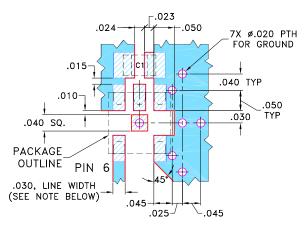
75Ω 0.3 to 475 MHz

PIN CONNECTIONS

PRIMARY DOT	6
PRIMARY	3
SECONDARY DOT	1
SECONDARY	3

PRODUCT MARKING: N/A

DEMOBOARD MCL P/N: TB-TC9-1-75+ SUGGESTED PCB LAYOUT (PL-155)



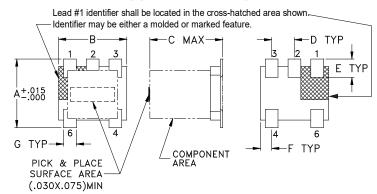
CAPACITOR C1: 0805 SIZE, FOR VALUE SEE CATALOG.

NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

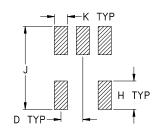
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER

MASK OVER BARE COPPER)
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout, Tolerance to be within±.002

OUTLINE DIMENSIONS (Inch)

F	.0:	E	D	C	B	A
25		. 040	. 050	.160	. 150	. 150
64		1.02	1.27	4.06	3.81	3.81
	gran		.030	J .190	H .065	G .028

TAPE & REEL INFORMATION: F17



RF Transformer

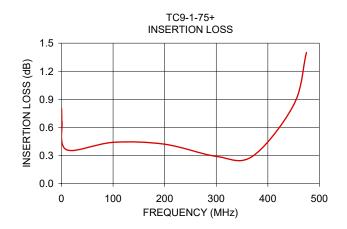
TC9-1-75+

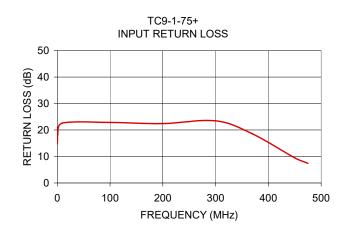
750

0.3 to 475 MHz

TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.30	0.80	14.70
0.50	0.71	16.80
0.90	0.66	18.13
10.00	0.36	22.63
100.00	0.44	22.86
200.00	0.42	22.40
300.00	0.29	23.48
370.00	0.29	18.53
450.00	0.84	9.48
475.00	1.40	7.44





NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



RF Transformer TC9-1-75+

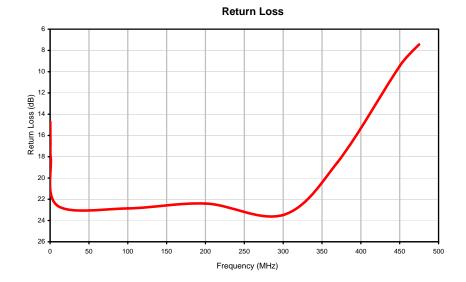
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.30	0.80	14.70
0.50	0.71	16.80
0.90	0.66	18.13
10.00	0.36	22.63
100.00	0.44	22.86
200.00	0.42	22.40
300.00	0.29	23.48
370.00	0.29	18.53
450.00	0.84	9.48
475.00	1.40	7.44

RF Transformer TC9-1-75+

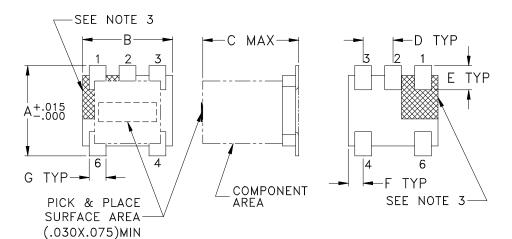
Typical Performance Curves



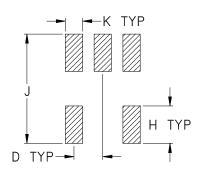


Outline Dimensions

AT224-1A



PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	С	D	Е	F	G	Н	J	K	WT. GRAMS
AT224-1A	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

- 1. Case material: Plastic.
- 2. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

3. Lead #1 identifier shall be located in the cross-hatched area shown. Identifier may be either a molded or marked feature.



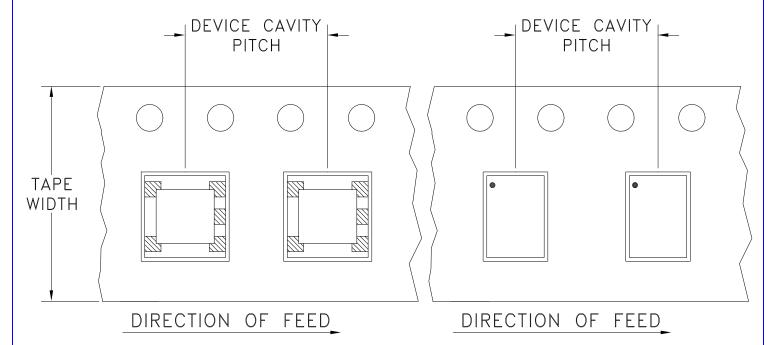


P.O. Box 350186, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices	s per Reel
			Small	20
			quantity	50
	12	7	standards	100
12	8		(see note)	200
				500
		12	12 84 - 1 - 1	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

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RF/IF MICROWAVE COMPONENTS

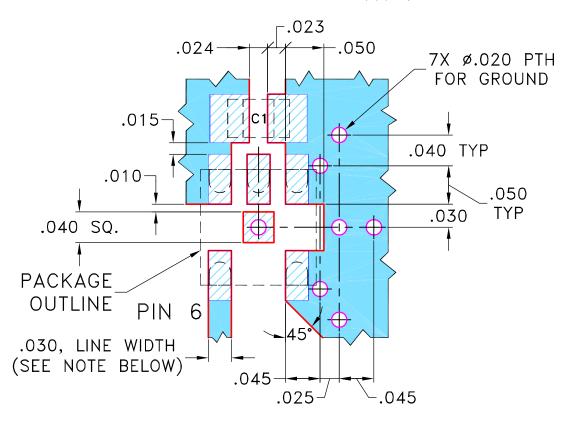
98-TR- Rev.: C (02/13/18) M166283 File: 98-TR-F17.docx This document and its contents are the property of Mini-Circuits.

Sheet 1 of 1

THIRD ANGLE	PROJECTION
<u></u>	
+ $+$	
\Box	

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M91565	NEW RELEASE	04/16/04	AV	IG
A	M102713	ADDED "WITH SMOBC"	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION FOR AT224 CASE STYLE, "pp/kp" PIN CONNECTION



CAPACITOR C1: 0805 SIZE, FOR VALUE SEE CATALOG.

NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

98PL155

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AV	03/23/04
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	IL	04/16/04
3 PL DECIMALS ± .005	APPROVED	IG	04/16/04
ANGLES ± FRACTIONS ±			

Mini-Circuits Brooklyn NY 11235

1 OF 1

 \square Mini-Circuits ${\bf @}$

ASHEETA1.DWG REV:A

DATE:01/12/95

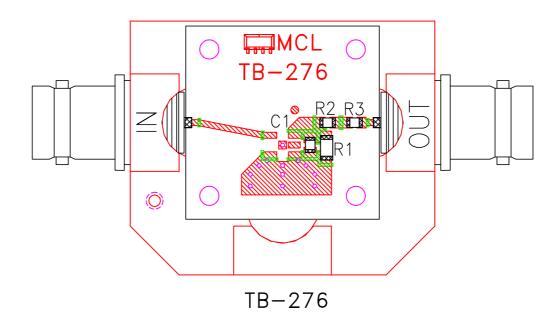
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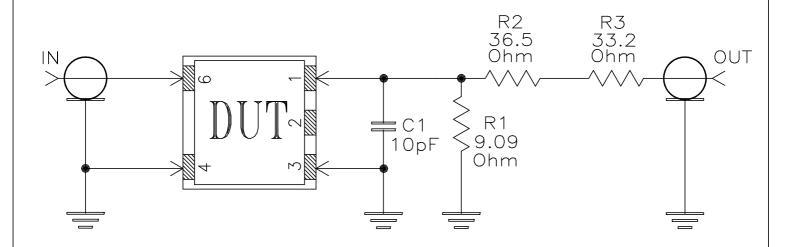
SIZE A	CODE IDENT 15542	DRAWING	NO: 98-PL	– 155		REV:	A
	10010			100			
TILE: (08PI 155	SCALE:	8 · 1	SHEET:	1	OF	1

8:1

PL, pp/kp, 75, AT224, TC9, TB-276

Evaluation Board and Circuit

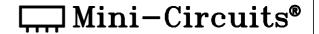




Schematic Diagram

Notes:

- 1. BNC Female connectors.
- 2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.





Environmental Specifications

ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02 Rev: A

02/25/11

M130240 File: ENV02.pdf